



Power Line Chokes

Current-compensated ring core chokes, 3-phase

Series/Type: **B8274*S***

Date: September 2025

Current-compensated ring core chokes, 3-phase

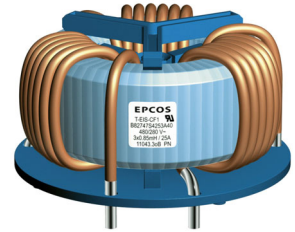
Rated voltage 440 to 690 V AC

Rated current 5.5 to 48 A

Nominal inductance 0.35 ... 6.2 mH

Construction

- Current-compensated ring core triple choke
- Plastic base plate and or holder (UL 94 V-0)
- Sector winding
- Hot-dip tinned ends of winding wires
- Open construction for forced and convection cooling
- Color of materials may vary



Features

- High resonance frequency
- Approx. 1.0% or even less stray inductance for symmetrical interference suppression
- Suitable for wave soldering
- Design complies with IEC/EN 60938-2
- UL 1446 class 155(F) electrical insulation system
- RoHS compatible



Applications

- Suppression of common-mode interferences
- Switch-mode applications
- Frequency-variable drives

Marking

Product brand (EPCOS), ordering code,
date of manufacture (YYWWD), production place identification code

Delivery mode

- Carton box

Technical data and measuring conditions

Test voltage V_{test}	2000 V AC / 2800 V DC, 2 s (line to line)
Rated temperature T_R	+70 °C
Rated current I_R	Referred to 50 Hz and rated temperature T_R (free-air convention cooling, shorted parallel wires per phase) ¹⁾
Nominal inductance L_N	Measured with Agilent 4284A, at 10 kHz, 0.1 mA +20 °C
Inductance tolerance	±30% at +20°C
Stray inductance $L_{\text{stray, typ}}$	Measured with Agilent 4284A, at 10 kHz, 5 mA, +20 °C, typical value
DC resistance R_{typ}	Measured at +20 °C, typical value, specified per phase
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5 (+245±3) °C, (3±0.3) s Wetting of soldering area ≥95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Pollution degree	P2 (to IEC 61558-1)
Storage conditions (packaged)	–25°C ... + 40 °C, ≤75% RH
Approvals (see assignment in table "Characteristics and ordering codes)	UL1446 Class 155(F) (E320370)

1) Current must be reduced when operating at higher ambient temperature than rated. See "Current derating" for details. Higher current can be applied by using an appropriate forced cooling approach. In any case, temperature of the coil is to be monitored and must not exceed the maximum value specified by the climatic category. The effect of magnetic saturation must be additionally considered when operated with higher current than specified.

Characteristics and ordering codes

I _R A	I _R ' A	V _R V	L _N mH	L _{stray,typ} μH	R _{typ} mΩ	Pin φ mm	Weight g	Figure No.	UL EIS	Ordering code
5.5		500	1.40	9	18	0.80	35	07		B82744S4552N030
6.9	7.7/+50°C	500	6.00 ¹⁾	36	17	1.18	105	18	X	B82746S4692A040
9		500	0.68	6.8	12	1.00	75	05	X	B82745S4902N001
10		520	1.70 ¹⁾	14	9.8	1.25	80	14		B82746S4103A020
10		500	2.00 ¹⁾	20	9.6	1.40	90	14		B82746S4103A021
11		440	1.10 ¹⁾	13	10	1.25	150	21	X	B82747H4113A020
12		500	1.80	10	6.8	1.50	85	19		B82746S4123N030
13	14/+60°C	550	3.20	16	6.5	1.80	175	13	X	B82746S4143A040
14	12/+85°C	600	0.35	4.7	3.7	1.50	55	08	X	B82745S6123N002
16		500	2.70 ³⁾	16	5.8	2.00	227	20		B82747S4163N030
17.5		500	0.68	4.9	3.9	1.80	105	06	X	B82745S4173N001
18		440	1.70 ³⁾	16	4.7	2.00	200	22		B82747S4183A020
18		440	1.80	17	4.7	2.00	250	11		B82747S4183N021
18		500	4.00 ¹⁾	30	5.2	2.24	300	03	X	B82747S4183B040
18.5	20/+60°C	520	1.30 ¹⁾	15	5.2	2.00	170	09		B82747S4203A020
20		500	0.75 ¹⁾	8	2.7	2.24	145	15	X	B82746S4203A020
20		500	1.15 ¹⁾	8	2.7	2.24	145	15	X	B82746S4203A040
23		500	1.50 ¹⁾	6.4	3.2	2.24	220	04	X	B82746S4233A040
30	25/+85°C	500	0.85 ²⁾	5.5	1.9	2.50	220	16	X	B82747S4253A040
31		500	0.95	5	1.5	2.80	220	10	X	B82747S6313N061
35	30/+85°C	500	0.82 ²⁾	4	1.4	2.80	230	16	X	B82747S4303A041
36	42/+50°C	440	1.50	10	2.6	2.80	480	12		B82747S4423N020
45		500	0.67	4.8	1.1	2.50	480	02	X	B82747S4453N001
46	50/+60°C	520	0.80 ¹⁾	7.5	1.5	3.35	430	01	X	B82748S4503A020
48	62/+40°C	690	1.10	9	1.6	3.35	780	17	X	B82748S6623N030
53	45/+85°C	500	0.30	0.7	0.83	2.50	480	02	X	B82747S4453N002

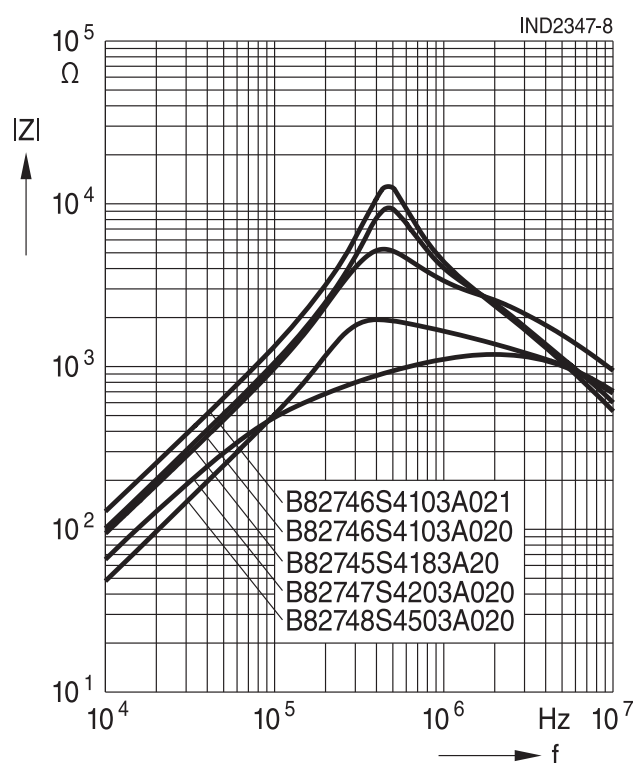
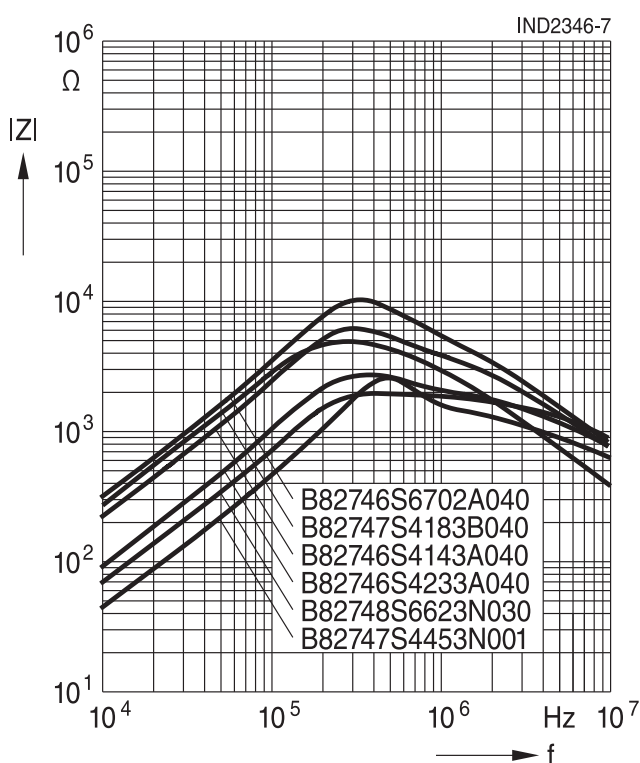
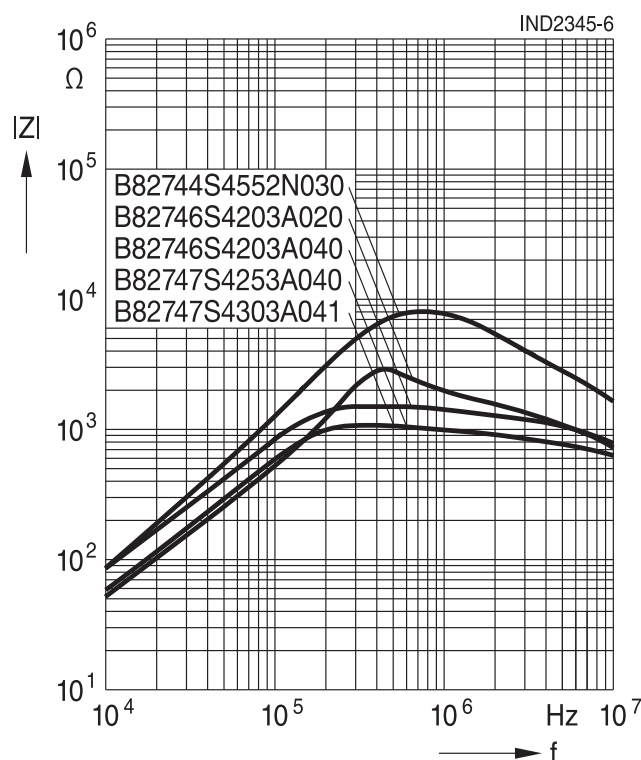
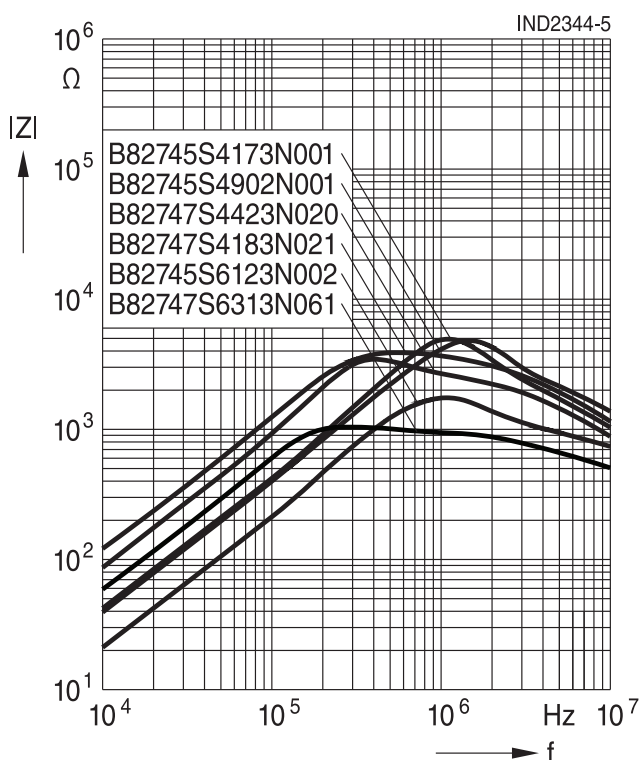
1) L_R tolerance -30/+50%

2) L_R tolerance +35%

3) L_R tolerance ±35%

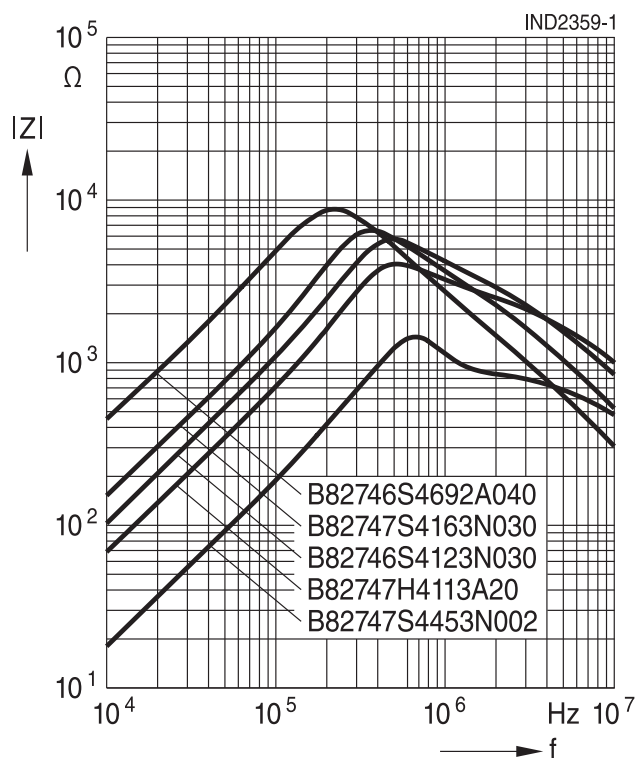
Impedance $|Z|$ versus frequency f

(measured with windings in parallel at +20 °C, typical values)



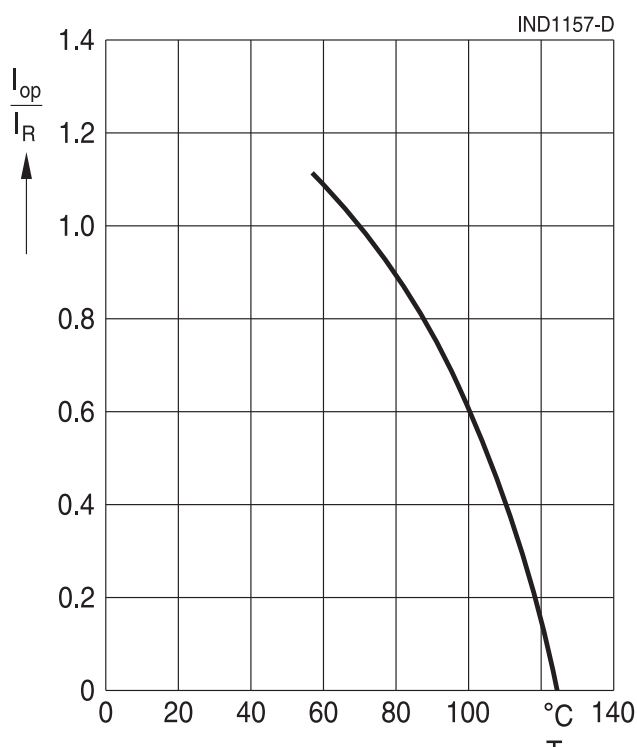
Impedance $|Z|$ versus frequency f

(measured with windings in parallel at +20 °C, typical values)



Current derating I_{op}/I_R versus temperature T_A

Rated temperature $T_R = +70$ °C



Current-compensated ring core chokes, 3-phase

Dimensional drawings and pin configuration

Figure 1 - B82748S4503A020

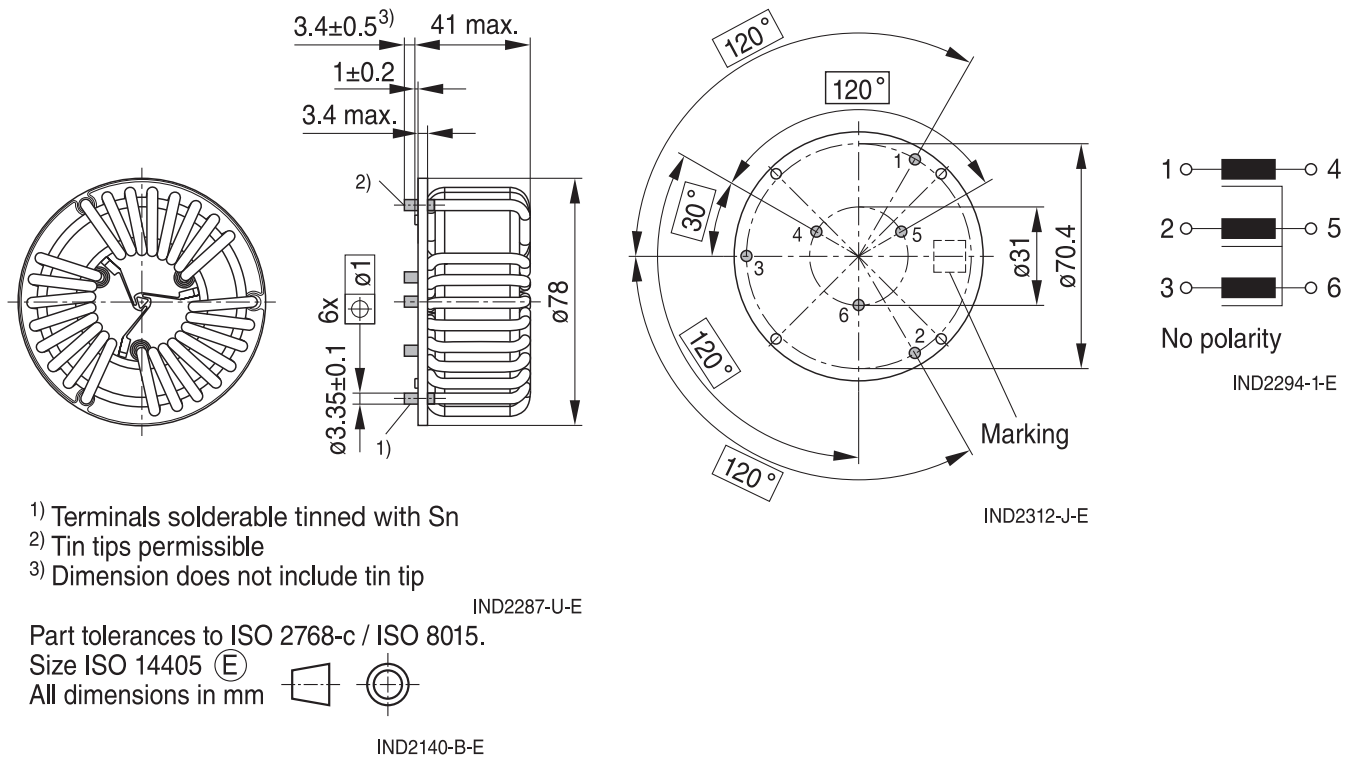


Figure 2 - B82747S4453N001, B82747S4453N002

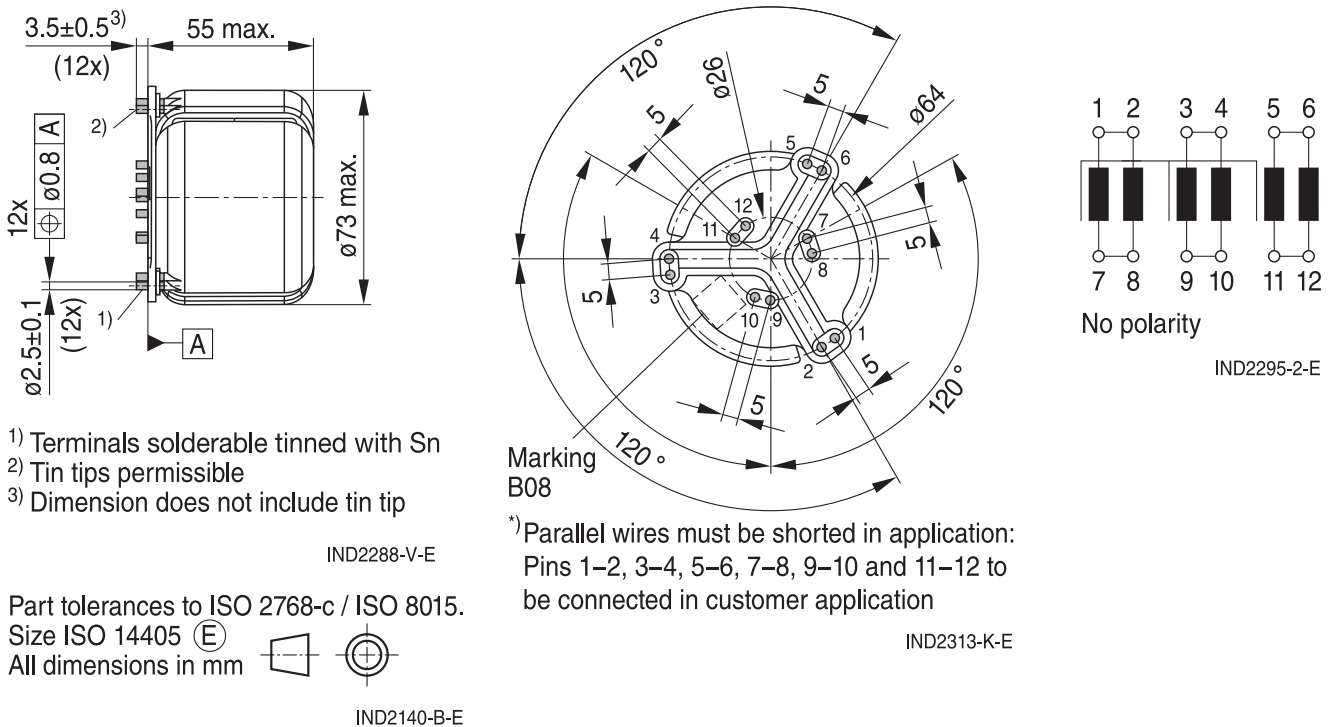
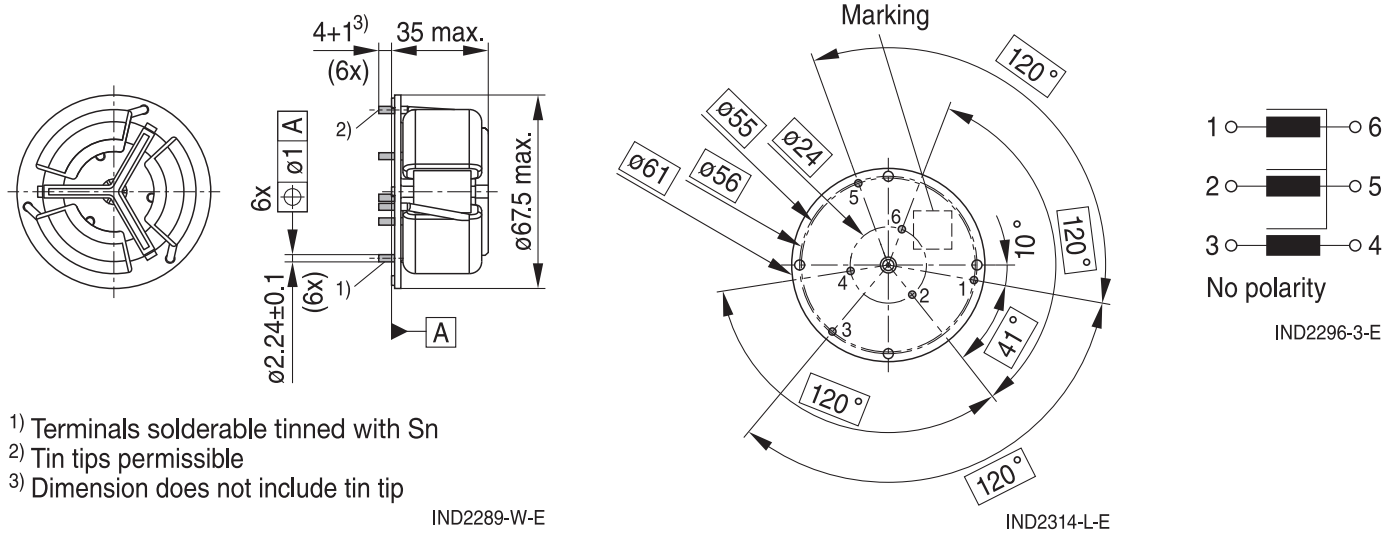


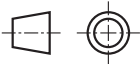
Figure 3 - B82747S4183B040



Part tolerances to ISO 2768-c / ISO 8015.

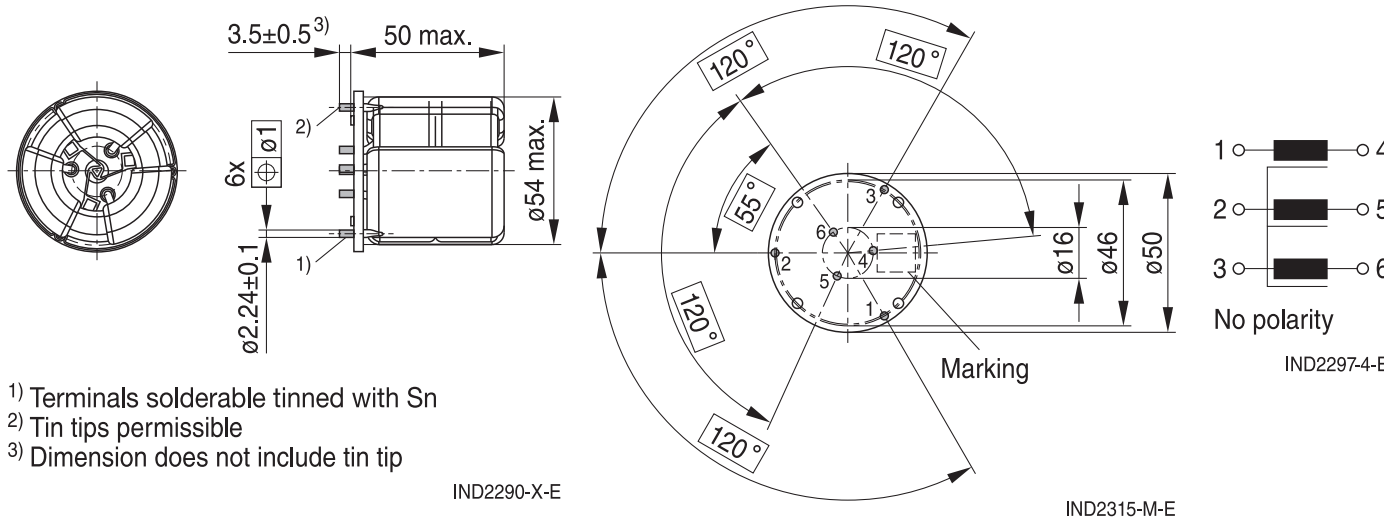
Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

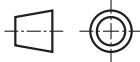
Figure 4 - B82746S4233A040



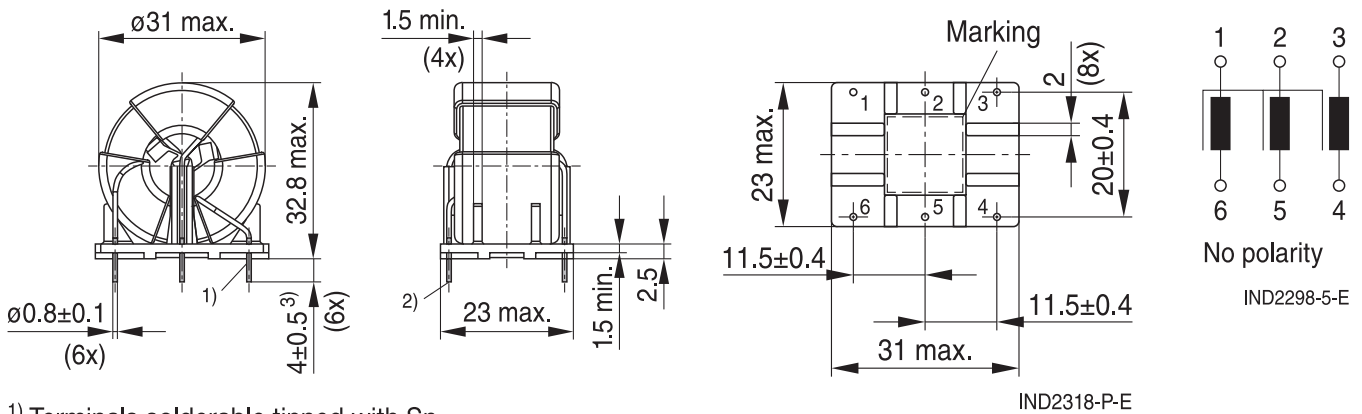
Part tolerances to ISO 2768-c / ISO 8015.

Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 7 - B82744S4552N030


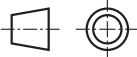
- 1) Terminals solderable tinned with Sn
- 2) Tin tips permissible
- 3) Dimension does not include tin tip

IND2293-0-E

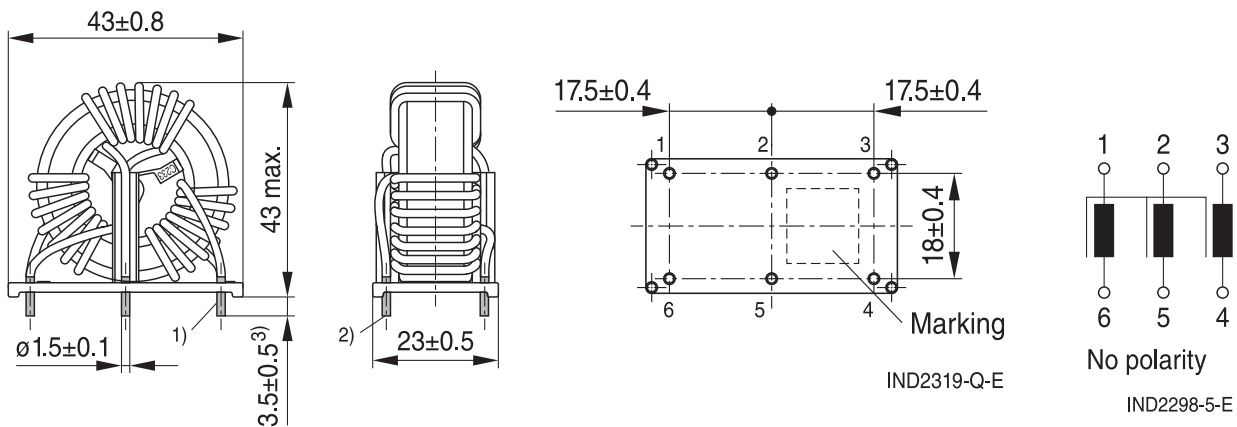
Part tolerances to ISO 2768-c / ISO 8015.

Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 8 - B82745S6123N002


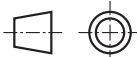
- 1) Terminals solderable tinned with Sn
- 2) Tin tips permissible
- 3) Dimension does not include tin tip

IND2301-8-E

Part tolerances to ISO 2768-c / ISO 8015.

Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 9 - B82747S4203A020

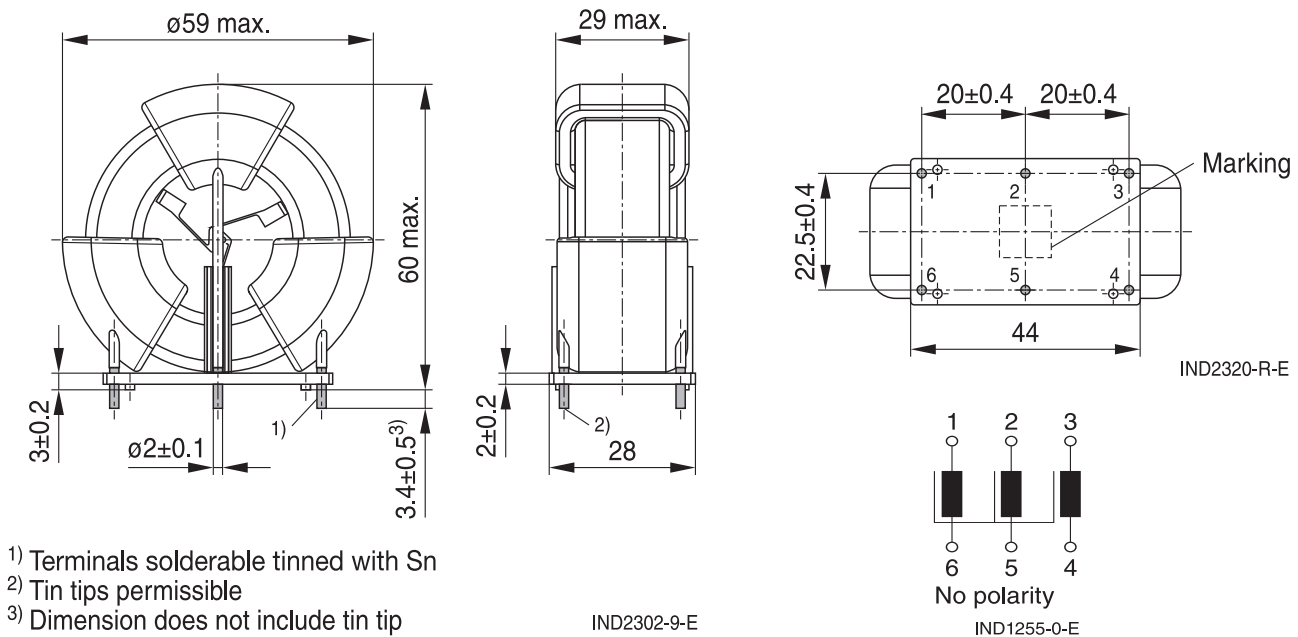


Figure 10 - B82747S6313N061

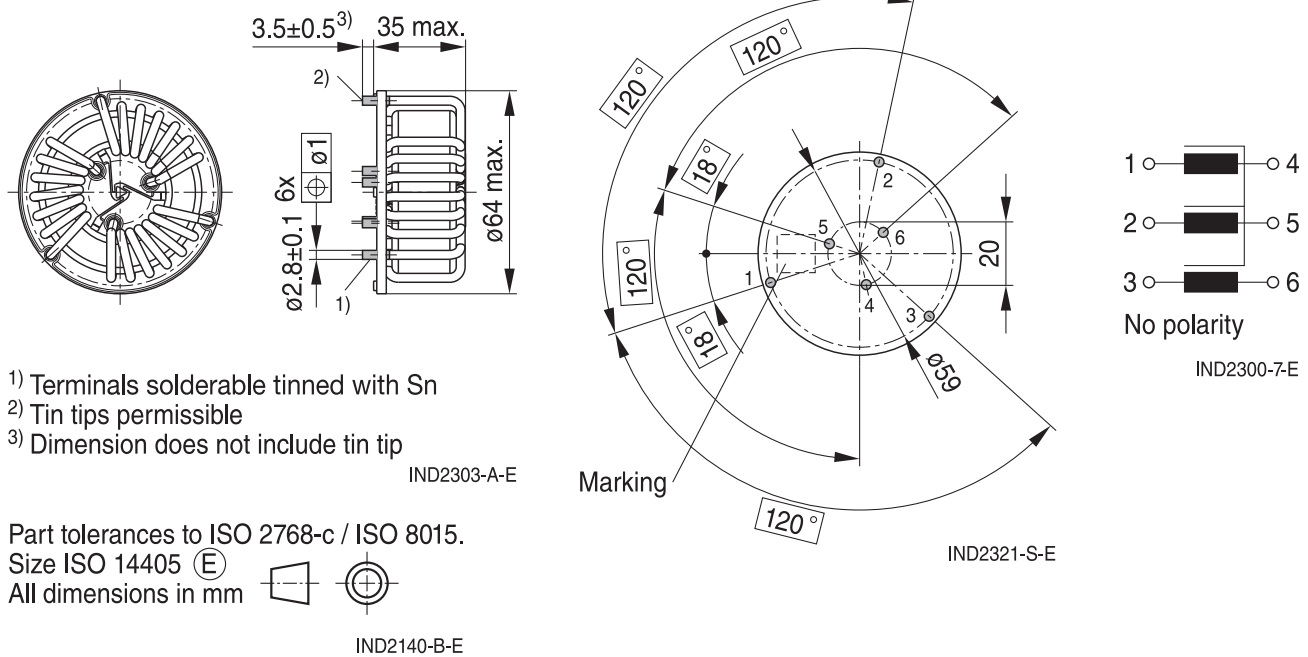
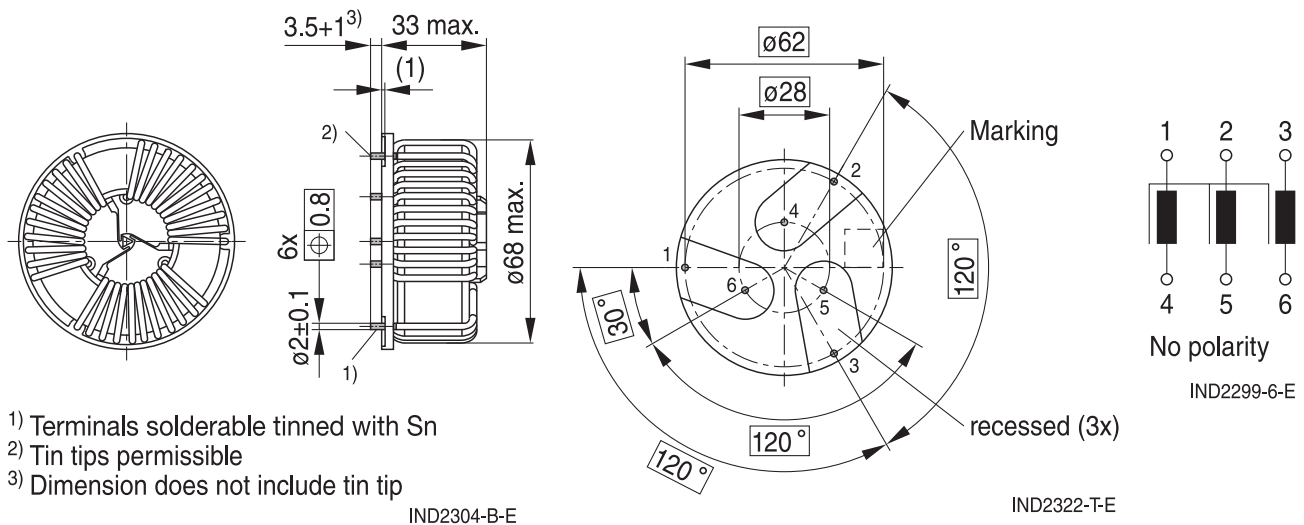


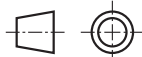
Figure 11 - B82747S4183N021



Part tolerances to ISO 2768-c / ISO 8015.

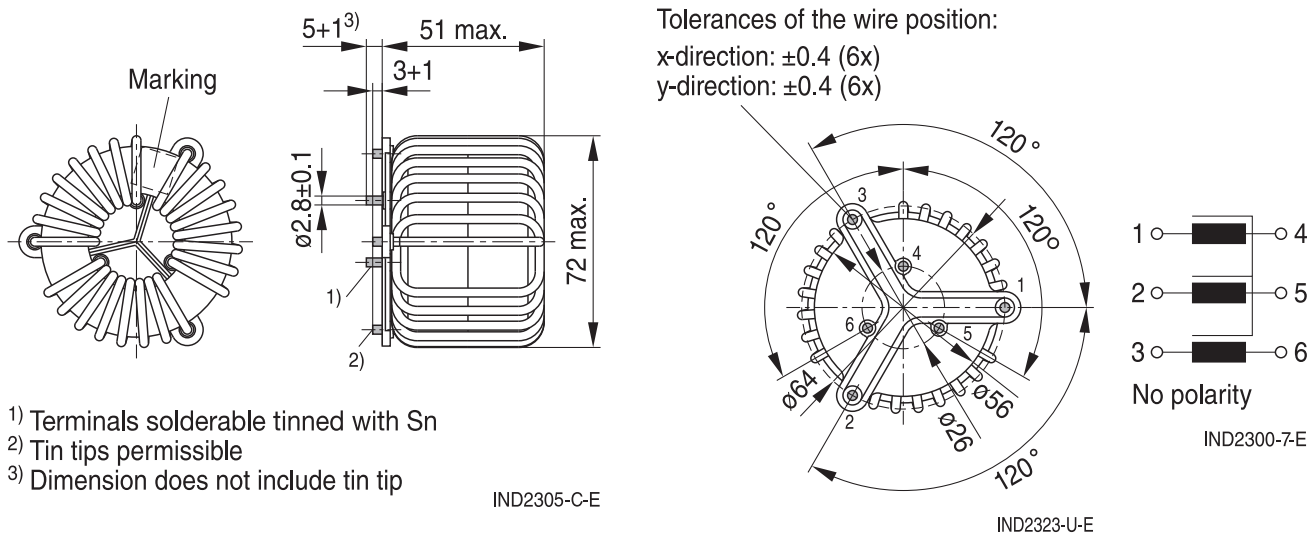
Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 12 - B82747S4423N020



1) Terminals solderable tinned with Sn

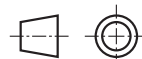
2) Tin tips permissible

3) Dimension does not include tin tip

Part tolerances to ISO 2768-c / ISO 8015.

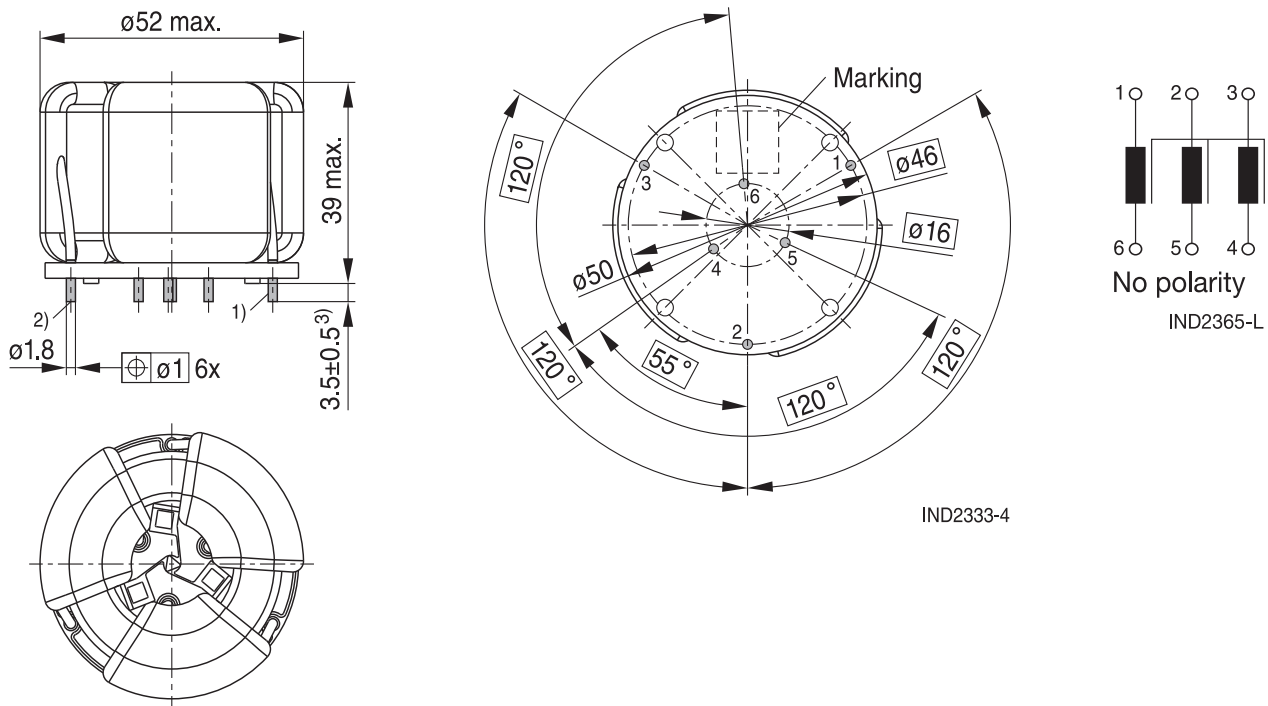
Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 13 - B82746S4143A040

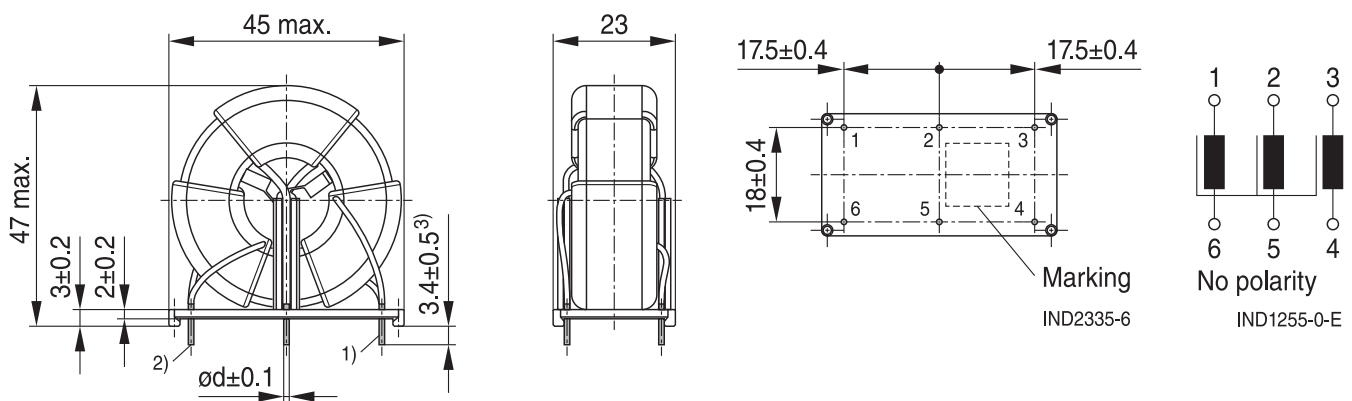


1) Terminals solderable tinned with Sn
2) Tin tips permissible
3) Dimension does not include tin tip

Part tolerances to ISO 2768-c / ISO 8015.
Size ISO 14405 (E)
All dimensions in mm

IND2334-5-E
IND2140-B-E

Figure 14 - B82746S4103A020, B82746S4103A021



1) Terminals solderable tinned with Sn
2) Tin tips permissible
3) Dimension does not include tin tip

Part tolerances to ISO 2768-c / ISO 8015.
Size ISO 14405 (E)
All dimensions in mm

IND2336-7-E
IND2140-B-E

Figure 15 - B82746S4203A020, B82746S4203A040

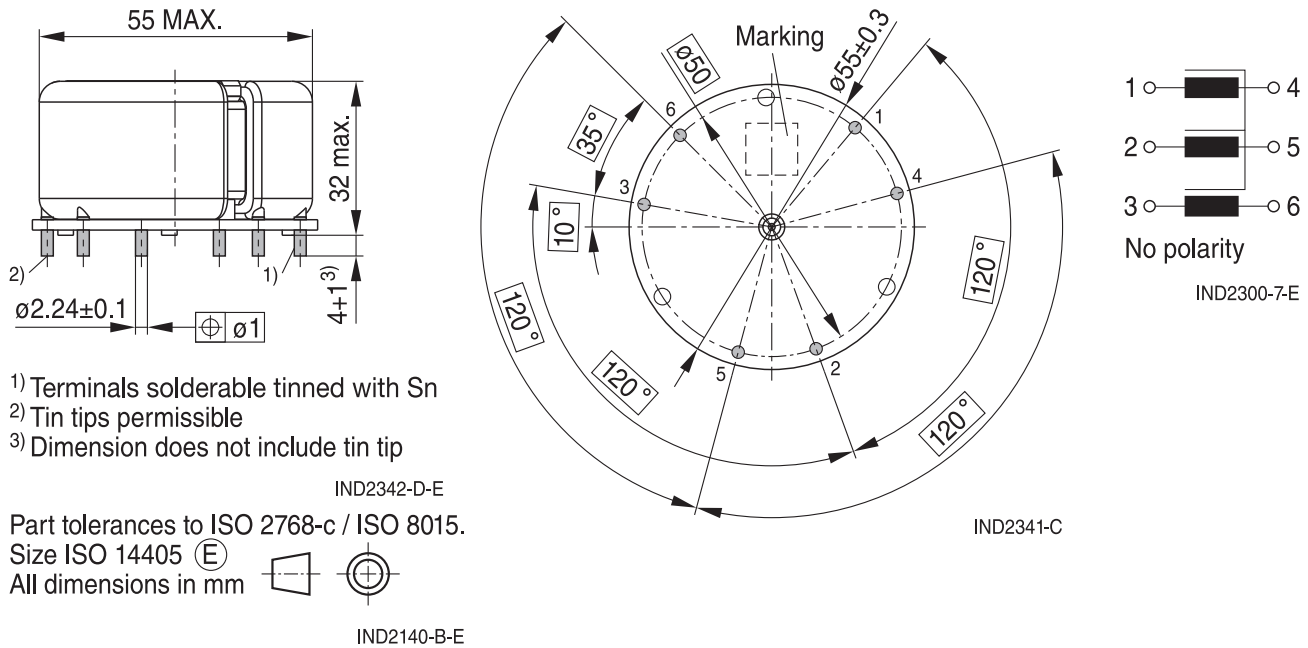


Figure 16 - B82747S4253A040, B82747S4303A041

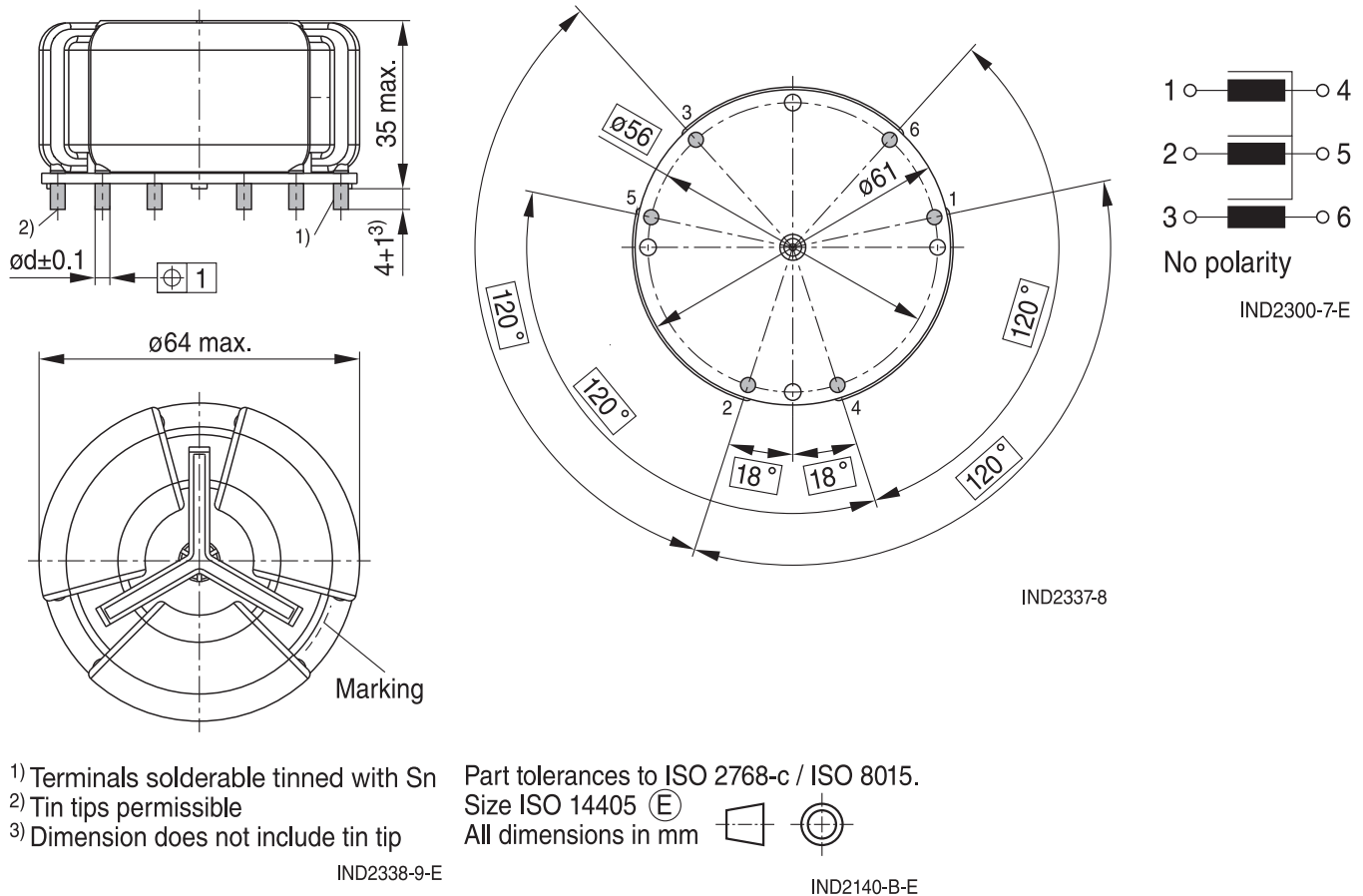


Figure 17 - B82748S6623N030

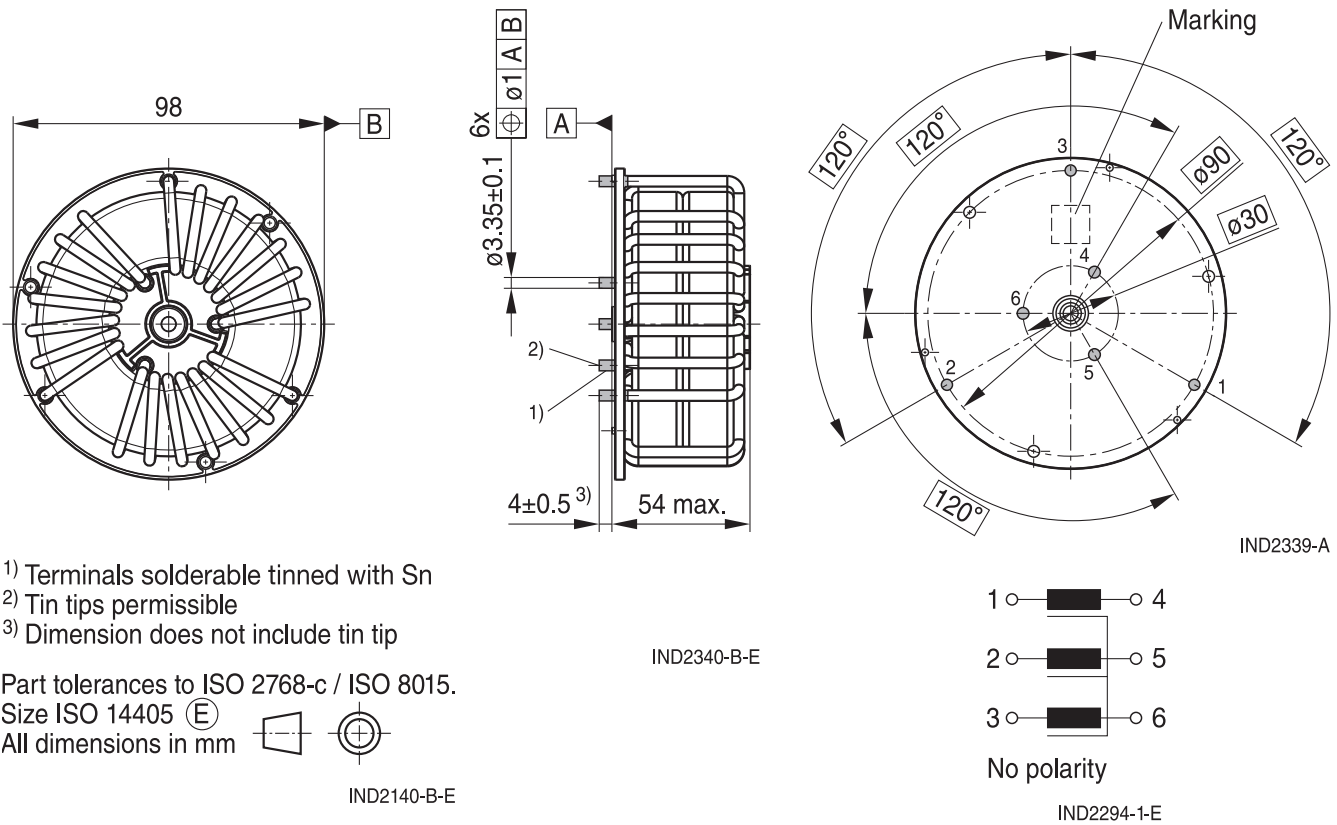


Figure 18 - B82746S4692A040

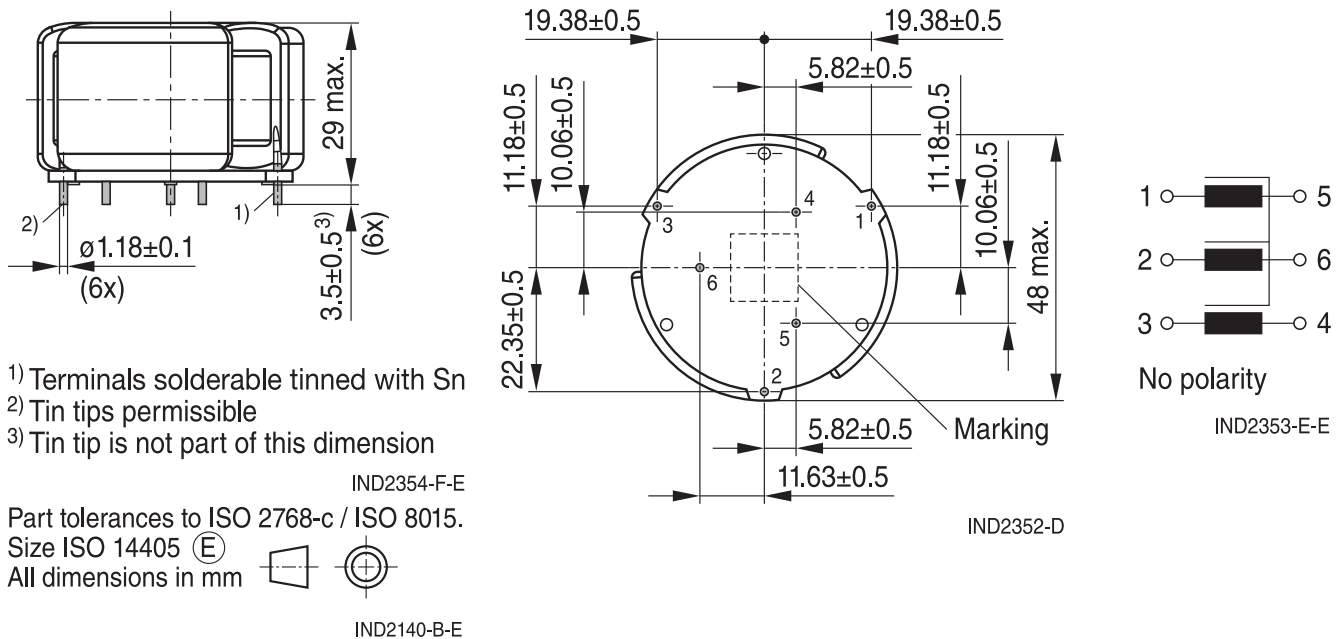
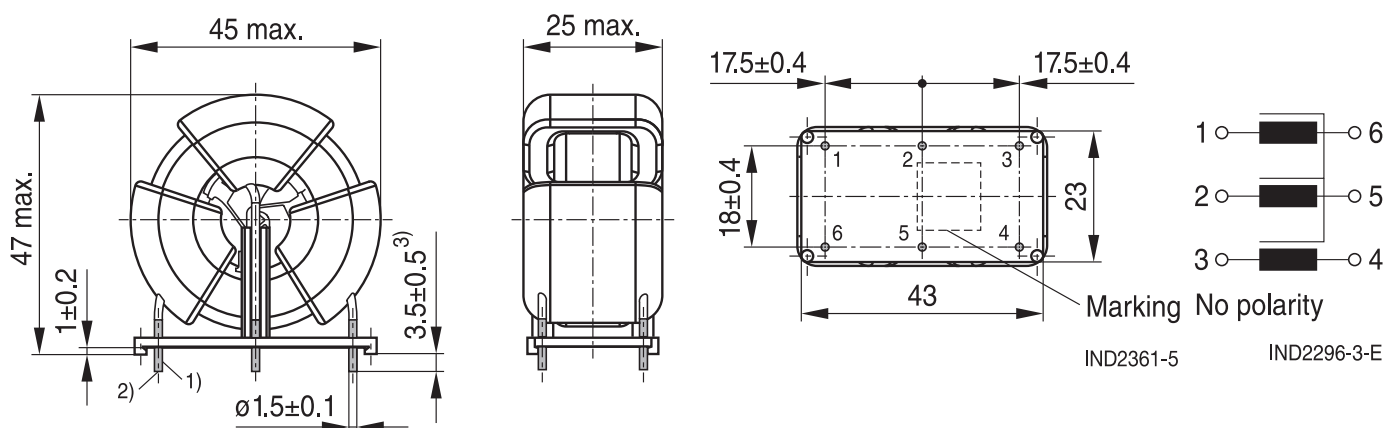


Figure 19 - B82746S4123N030



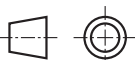
- 1) Terminals solderable tinned with Sn
 2) Tin tips permissible
 3) Tin tip is not part of this dimension

IND2387-4-E

Part tolerances to ISO 2768-c / ISO 8015.

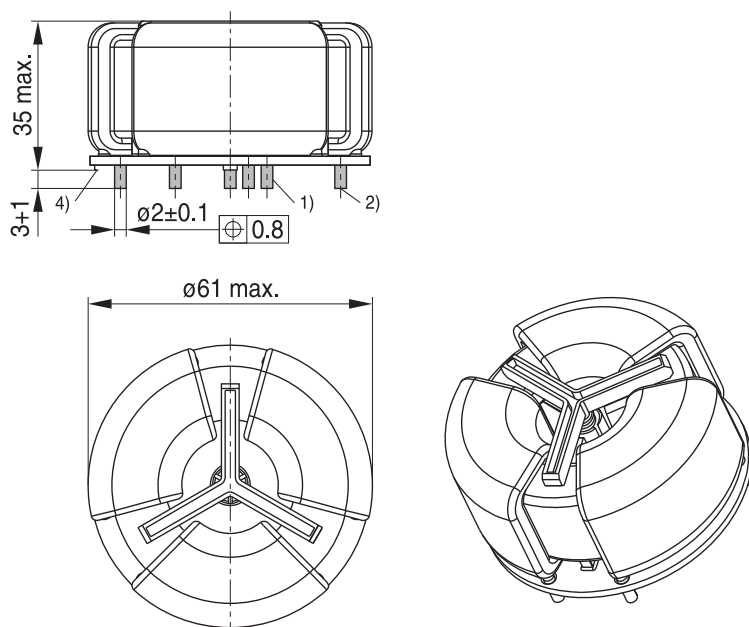
Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

Figure 22 - B82747S4183A020

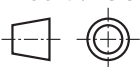


- 1) Terminals solderable tinned with Sn
- 2) Tin tips permissible
- 3) Dimension does not include tin tip
- 4) Standoffs: 1 mm ref.

Part tolerances to ISO 2768-c / ISO 8015.

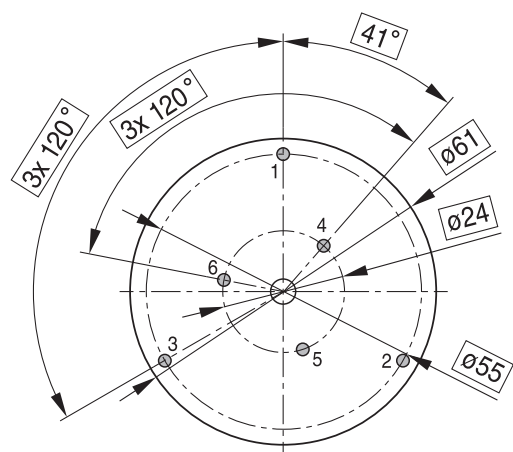
Size ISO 14405 (E)

All dimensions in mm

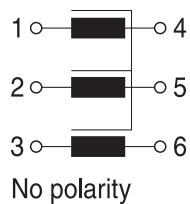


IND2140-B-E

IND2370-4-E



IND2369-V



IND2300-7-E

Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Release 2024-08-08

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Important notes

The following applies to all products named in this publication:

- 1 Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2 We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3 **The warnings, cautions and product-specific notes must be observed.**
- 4 In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5 We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6 Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.
- 7 **Our manufacturing sites serving the automotive business apply the IATF 16949 standard**. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.

Important notes

- 8 The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2024-02